ASSOCIATION CONNECTING ELECTRONCE INDUSTRES® INDUSTRES®	annockburn, Illinois.	All rights reserved entions.	under both This docu level part	ment is a declarati	aration of the	e substances sses all lowe	within the manufactur er level materials for w	rer listed ite hich the ma	em. Note: if anufacturer	the item is an as has engineering	sembly with lower responsibility.
	.1 IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Dist							als and Mfg Information			
Supplier Information											
bompany name* Company unique ID				Unique ID Authority				Response Date*			
onsemi								2023-06-08			
Contact Name	Name Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards	duct-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
uthorized Representative* Title - Representative				Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Cor			o Compliance		NA			Product-Env-Stewards@onsemi.com			
Requester Item Number N	Afr Item Number	Mfr Item Name		Effective I	ate Versi	ion	Manufacturing Site		Veight*	UOM	Unit Type
I	LE2416RDXATDG	2416RDXATDG 16K bit I2C Fast-Pl WLCSP		V, 2023-06-0	3	РНМ		0	.91119	mg	Each
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material	Terminal Base	Terminal Base Alloy J-S		Peak I	Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		cles		
SnAgCu CU Alloy 1		1	260		С	30	second	ls 3			
Comments											
level 1 - maximum time at peak temperature du	ring soldering is 10	30 seconds									
For more information regarding material comp	osition please refer	to page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.342	mg		Epoxy resin	proprietary data		0.0716	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0063	mg
			Supplier	Acrylic resins	Proprietary Data		0.0716	mg
			Supplier	Silica (SiO2)	14464-46-1		0.1925	mg
Die	0.41572	mg	Supplier	Silicon (Si)	7440-21-3		0.4157	mg
Electrode 0.0	0.06569	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.0655	mg
Protection coat	0.01646	mg		Polyimide	proprietary data		0.0165	mg
Solder Ball	0.07132	mg	Supplier	Silver (Ag)	7440-22-4		0.0029	mg
			Supplier	Tin (Sn)	7440-31-5		0.0681	mg
			Supplier	Copper (Cu)	7440-50-8		0.0004	mg